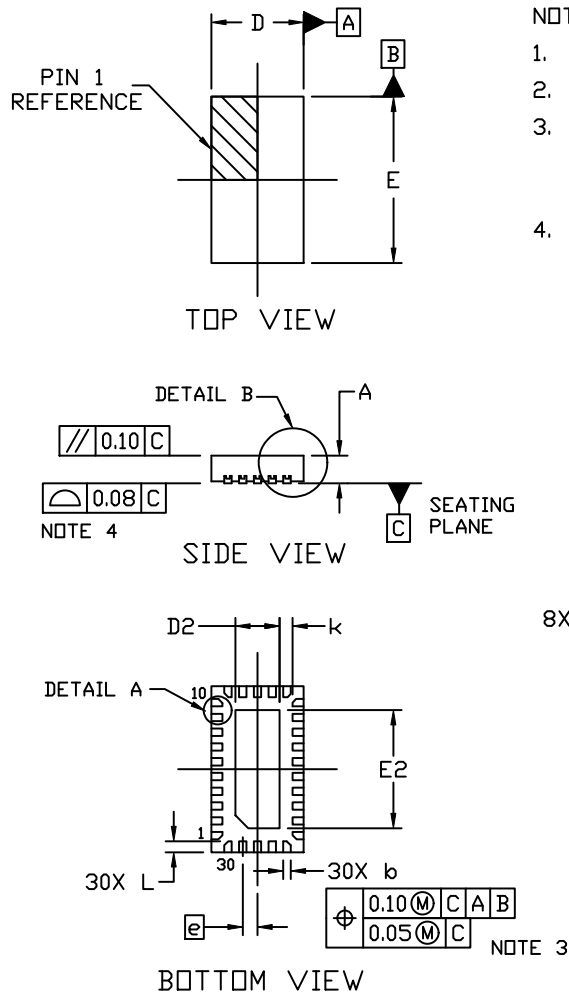


WQFN30 2.50x4.50, 0.4P
CASE 510CK
ISSUE B

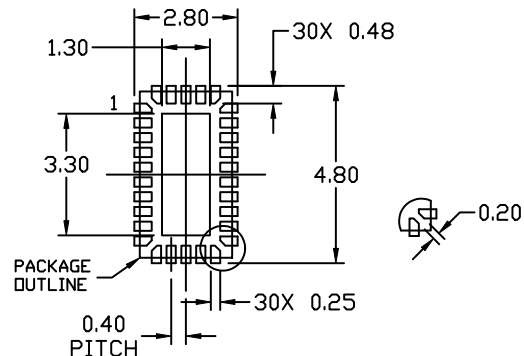
DATE 21 MAY 2020



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS		
	MIN.	NDM.	MAX.
A	0.70	0.75	0.80
A1	---	---	0.05
b	0.15	0.20	0.25
b2	0.20 REF		
D	2.40	2.50	2.60
D2	1.15	1.20	1.25
E	4.40	4.50	4.60
E2	3.15	3.20	3.25
e	0.40 BSC		
K	0.20 REF		
L	0.25	0.30	0.35
L2	0.10 REF		


GENERIC MARKING DIAGRAM*


A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	WQFN30 2.50x4.50, 0.4P	PAGE 1 OF 1

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